

1.25mm Contact Spacing, Board to Wire Dip Connectors EBW-PK23 SERIES

FEATURES

- Pin header finish Tin-Lead or Tin Plating.
- Apply PCB hole dimension 0.6±0.03
- Please consult ECE for availability.

SPECIFICATIONS

1.ELECTRICAL

- Voltage rating: 200V
- Current rating: 1A
- Contact resistance: 20mΩ max.(initial)
- Insulation resistance: 100MΩ min.

MATERIALS

1.MATERIAL

- Contacts: Copper Alloy
- Insulator Housing: High Temp. Thermoplastic

2.MECHANICAL

- Durability: Mate & Unmate with applicability for 50 times, Contact resistance: 40mΩ max.
- Connector Mating Force: 0.5kgf*n (4.9N*n) max.
- Connector Unmating Force: 0.03kgf*n (0.294N*n) min.(exclude LOCK)

2.PLATING

- Contact:
- Nickel In All Area
- Terminal entire: Tin-Lead over Nickel Tin over Nickel (RoHS Compliance)

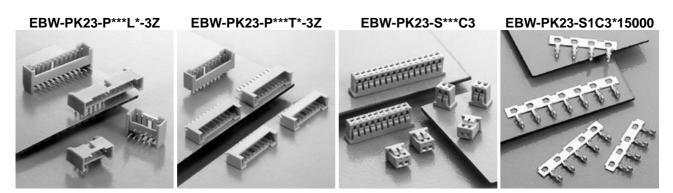
PACKING

1.Packing method

1-1.All connector are packed in bulk method.

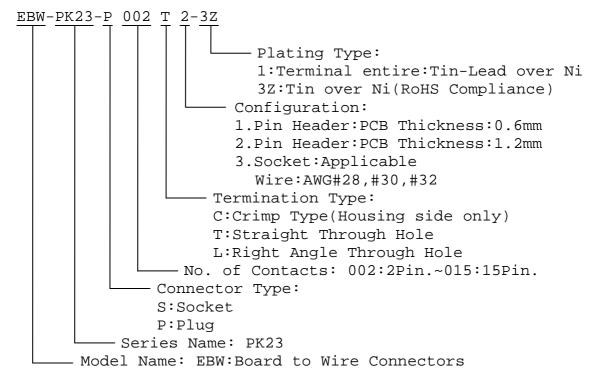
2.Information on label (stuck to each ploy bag, reel and box)

(1)Part NO.	(2)Section.	(3)Lot NO.	(4)Quantity.
(5)QC stamp.	(6)Reprocess NO.	(7)ECE mark.	

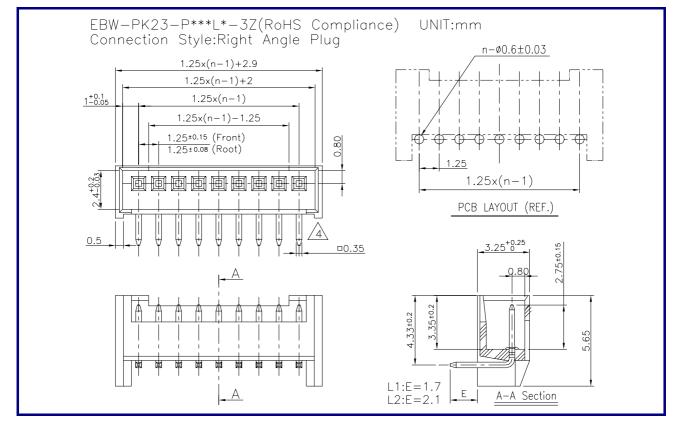




PART NUMBERING SYSTEM



DRAWING

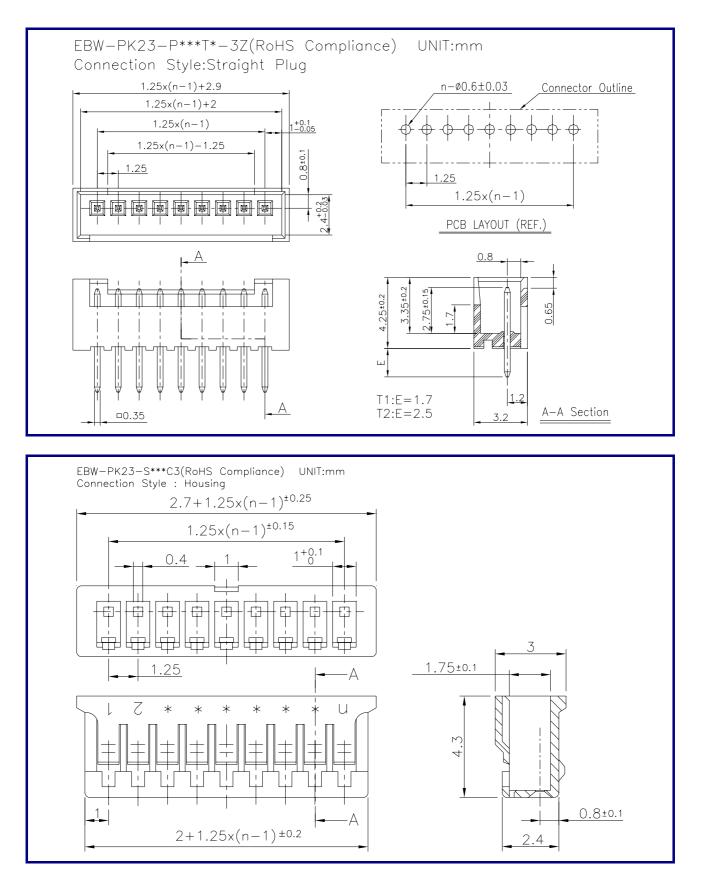


For the latest product information Please visit our website at <u>www.ece.com.tw</u>



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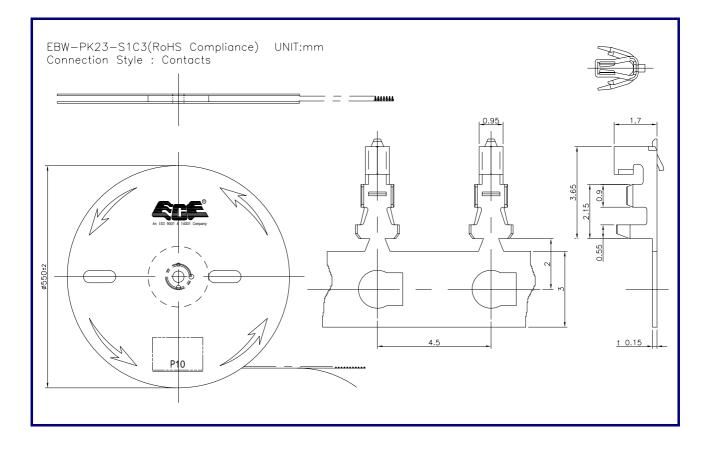


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